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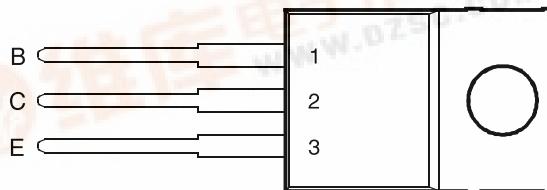


TRANSYS
ELECTRONICS
LIMITED

BDX54, BDX54A, BDX54B, BDX54C PNP SILICON POWER DARLINGTONS

- Designed for Complementary Use with BDX53, BDX53A, BDX53B and BDX53C
- 60 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	-45	V
		-60	
		-80	
		-100	
Collector-emitter voltage ($I_B = 0$)	V_{CEO}	-45	V
		-60	
		-80	
		-100	
Emitter-base voltage	V_{EBO}	-5	V
Continuous collector current	I_C	-8	A
Continuous base current	I_B	-0.2	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)	P_{tot}	60	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)	P_{tot}	2	W
Operating junction temperature range	T_j	-65 to +150	°C
Operating temperature range	T_{stg}	-65 to +150	°C
Operating free-air temperature range	T_A	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.48 W/°C.

2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDX54 BDX54A BDX54B BDX54C	-45 -60 -80 -100			V
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BDX54		-0.5		
		$V_{CE} = -30 \text{ V}$	$I_B = 0$		BDX54A		-0.5		mA
		$V_{CE} = -40 \text{ V}$	$I_B = 0$		BDX54B		-0.5		
		$V_{CE} = -50 \text{ V}$	$I_B = 0$		BDX54C		-0.5		
I_{CBO}	Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BDX54		-0.2		
		$V_{CB} = -60 \text{ V}$	$I_E = 0$		BDX54A		-0.2		mA
		$V_{CB} = -80 \text{ V}$	$I_E = 0$		BDX54B		-0.2		
		$V_{CB} = -100 \text{ V}$	$I_E = 0$		BDX54C		-0.2		
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-2		mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)		750			
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)			-2.5		V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)			-2		V
V_{EC}	Parallel diode forward voltage	$I_E = -3 \text{ A}$	$I_B = 0$				-2.5		V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.08	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS [†]			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = 4.2 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}, dc \leq 2\%$		5		μs

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

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TYPICAL CHARACTERISTICS

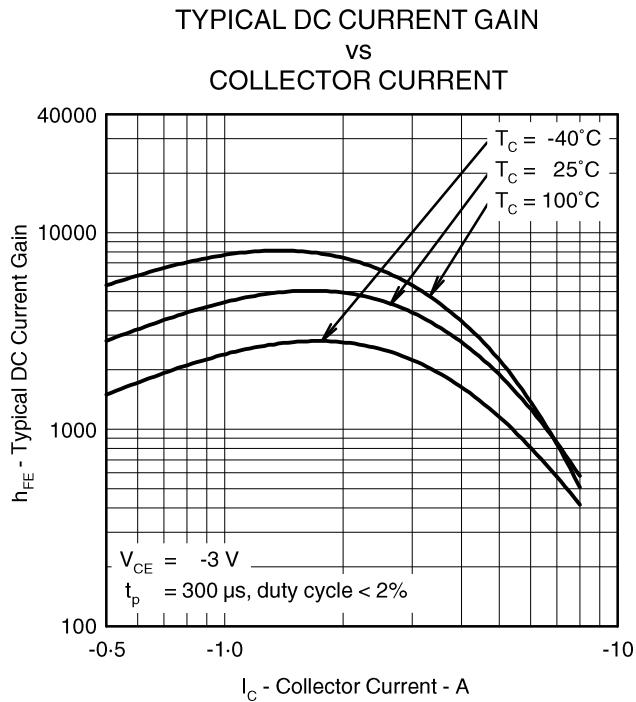


Figure 1.

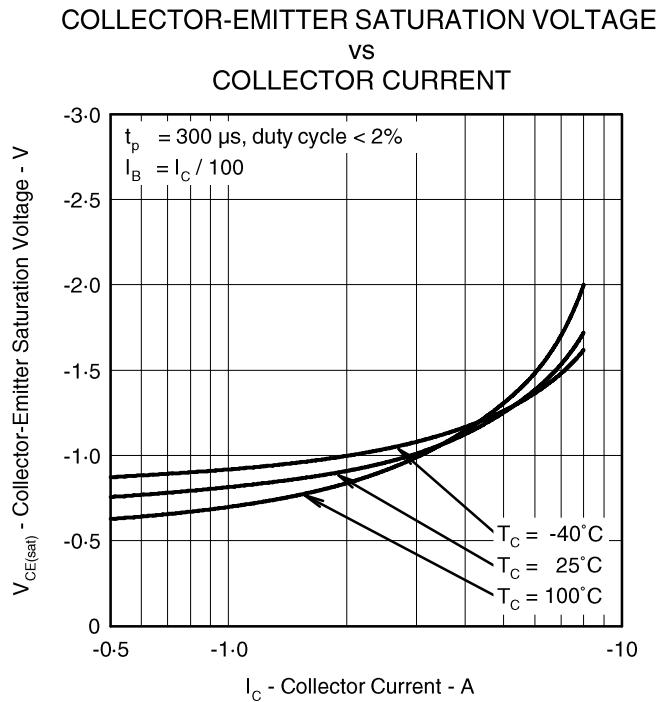


Figure 2.

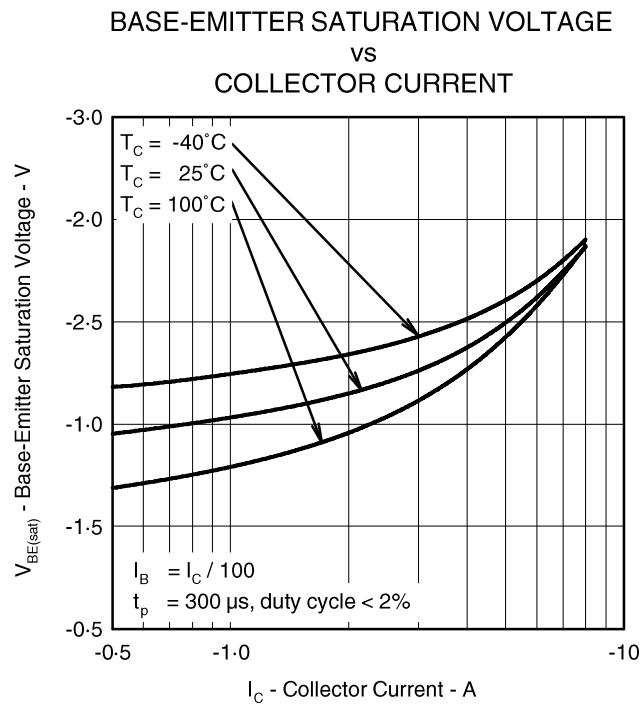


Figure 3.

BDX54, BDX54A, BDX54B, BDX54C PNP SILICON POWER DARLINGTONS

MAXIMUM SAFE OPERATING REGIONS

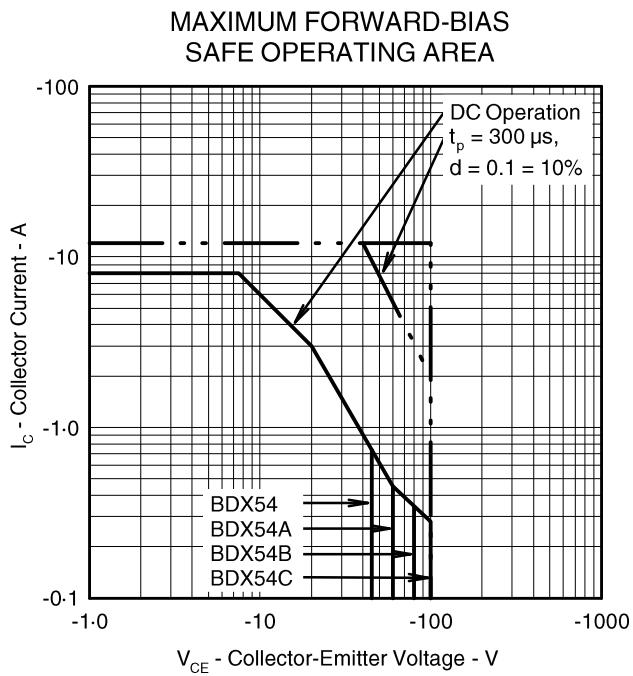


Figure 4.

THERMAL INFORMATION

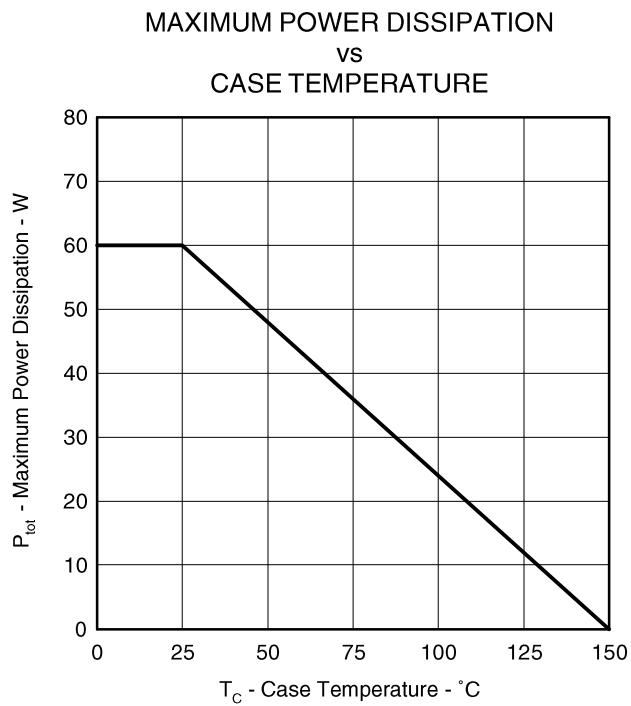


Figure 5.

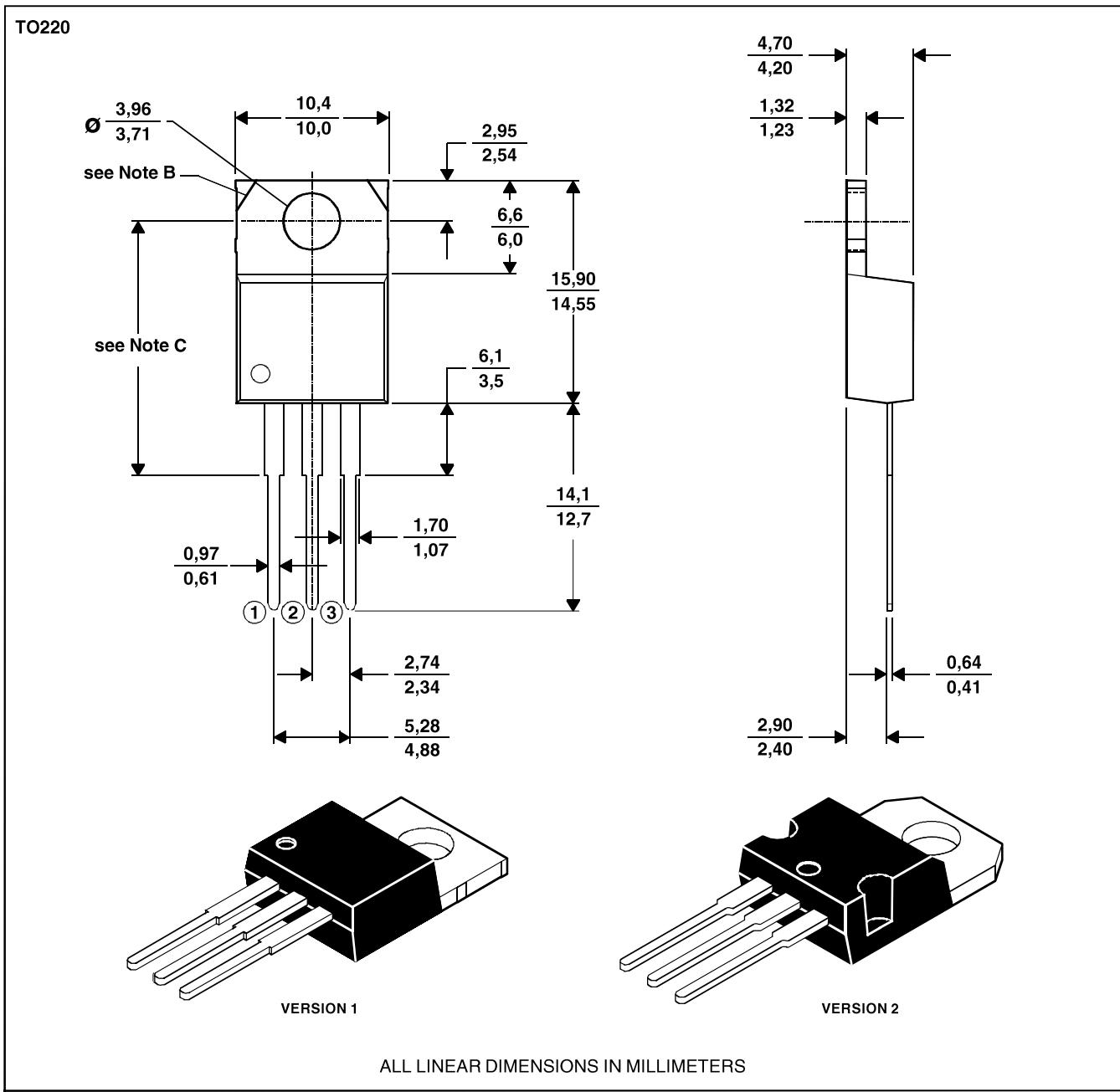
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MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



- NOTES:
- A. The centre pin is in electrical contact with the mounting tab.
 - B. Mounting tab corner profile according to package version.
 - C. Typical fixing hole centre stand off height according to package version.
Version 1, 18.0 mm. Version 2, 17.6 mm.